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SEMICONDUCTOR®

FDT86256

N-Channel PowerTrench[®] MOSFET 150 V, 1.2 A, 845 m Ω

Features

- Max $r_{DS(on)}$ = 845 m Ω at V_{GS} = 10 V, I_D = 1.2 A
- Max $r_{DS(on)}$ = 1280 m Ω at V_{GS} = 6.0 V, I_D = 1.0 A
- Very low Qg and Qgd compared to competing trench technologies
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant

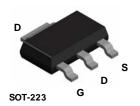


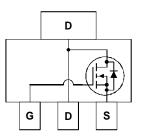
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize the on-state resistance and switching loss. G-S zener has been added to enhance ESD voltage level.

Applications

- DC-DC conversion
- Inverter
- Synchronous Rectifier





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol		P	Ratings	Units		
V _{DS}	Drain to	Source Voltage	150	V		
V _{GS}	Gate to \$	Source Voltage	±20	V		
ID	Drain Cu	rrent -Continuous (Packa	3			
		-Continuous (Silicor	2.5	•		
		-Continuous	T _A = 25	°C (Note 1a)	1.2	Α
		-Pulsed	2			
E _{AS}	Single P	ulse Avalanche Energy		(Note 3)	1	mJ
P _D	Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$				10	W
	Power D	issipation	T _A = 25 °C	(Note 1a)	2.3	vv
T _J , T _{STG}	Operatin	g and Storage Junction Te	-55 to +150	°C		
Thermal Ch		stics Resistance. Junction to Ca	250		12	
R _{0JC}		,		°C/W		
R_{\thetaJA}	Inermai	Resistance, Junction to Ar	55			
Package M	arking aı	nd Ordering Informa	tion			
Device Marking		Device	Package	Reel Size	Tape Width	Quantity
86256		FDT86256	SOT-223	13 "	12 mm	2500 units

August 2011

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V	
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature	$I_D = 250 \ \mu$ A, referenced to 25 °C		100		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	3.5	4	V	
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	to Source Threshold Voltage $I_{D} = 250 \mu A$ referenced to 25 °C.		-8		mV/°C	
r _{DS(on)}		V _{GS} = 10 V, I _D = 1.2 A		695	845		
	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 1.0 A		912	2 1280 mΩ		
		$V_{GS} = 10 \text{ V}, \ \text{I}_{D} = 1.2 \text{ A}, \ \text{T}_{J} = 125 \ ^{\circ}\text{C}$		1298	1367		
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 1.2 A		0.3		S	
Dvnamic	Characteristics						
C _{iss}	Input Capacitance			55	73	pF	
C _{oss}	Output Capacitance	$V_{\rm DS} = 75 \text{V}, V_{\rm GS} = 0 \text{V},$		8	11	pF	
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		1	1.4	pF	
Rg	Gate Resistance			1.3		Ω	
Switching	Characteristics						
t _{d(on)}	Turn-On Delay Time			2.7	10	ns	
t _r	Rise Time	V _{DD} = 75 V, I _D = 1.2 A,		1.7	10	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		4.8	10	ns	
t _f	Fall Time			2.6	10	ns	
Q _{g(TOT)}	Total Gate Charge	V _{GS} = 0 V to 10 V		1.2	2.0	nC	
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V V_{DD} = 75 V,$		0.8	1.0		
Q_{gs}	Gate to Source Charge	I _D = 1.2 A		0.4		nC	
Q _{gd}	Gate to Drain "Miller" Charge			0.3		nC	
0	urce Diode Characteristics						
V _{SD}		$V_{GS} = 0 V, I_{S} = 1.2 A$ (Note 2)		0.9	1.3	V	
	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 1.0 A$ (Note 2)		0.8	1.3		
t _{rr}	Reverse Recovery Time			47	75	ns	
Q _{rr}	Reverse Recovery Charge	– I _F = 1.2 A, di/dt = 100 A/μs		24	38	nC	

NOTES:

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a) 55 °C/W when mounted on a 1 in² pad of 2 oz copper

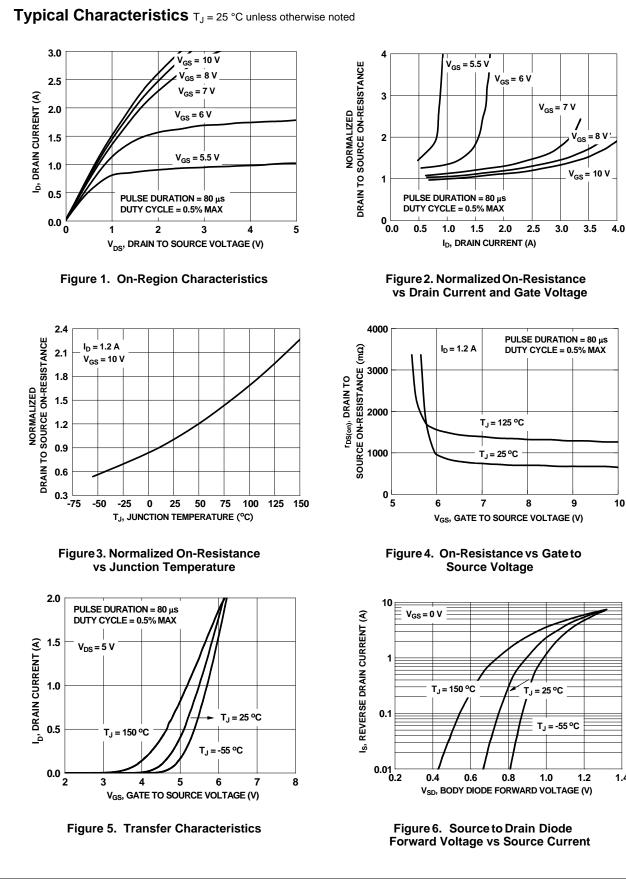


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b) 118 °C/W when mounted on a minimum pad of 2 oz copper

Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0 %.
Starting T_J = 25 °C, L = 3 mH, I_{AS} = 1 A, V_{DD} = 150 V, V_{GS} = 10 V.
The diode connected between gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

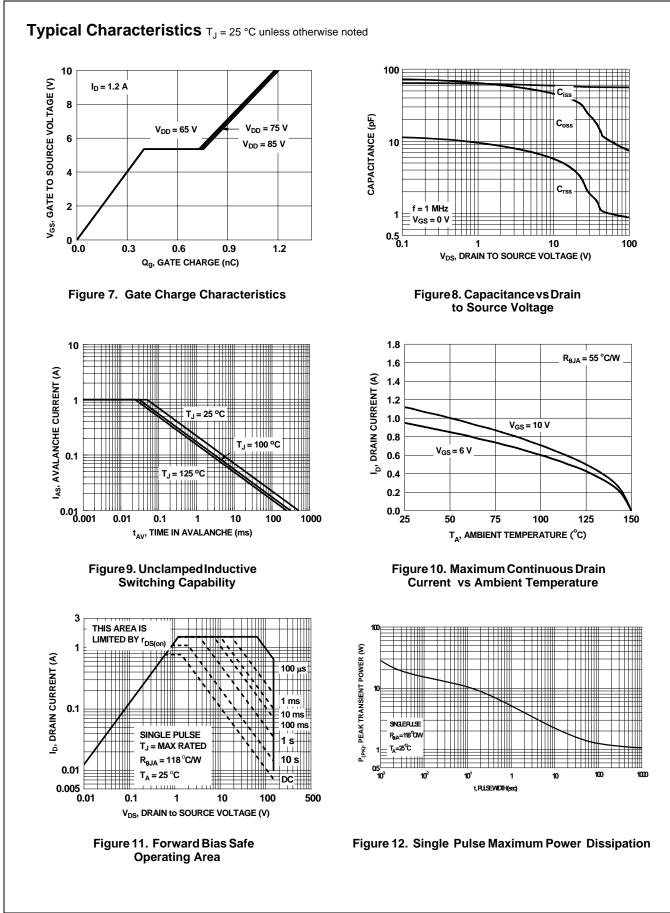
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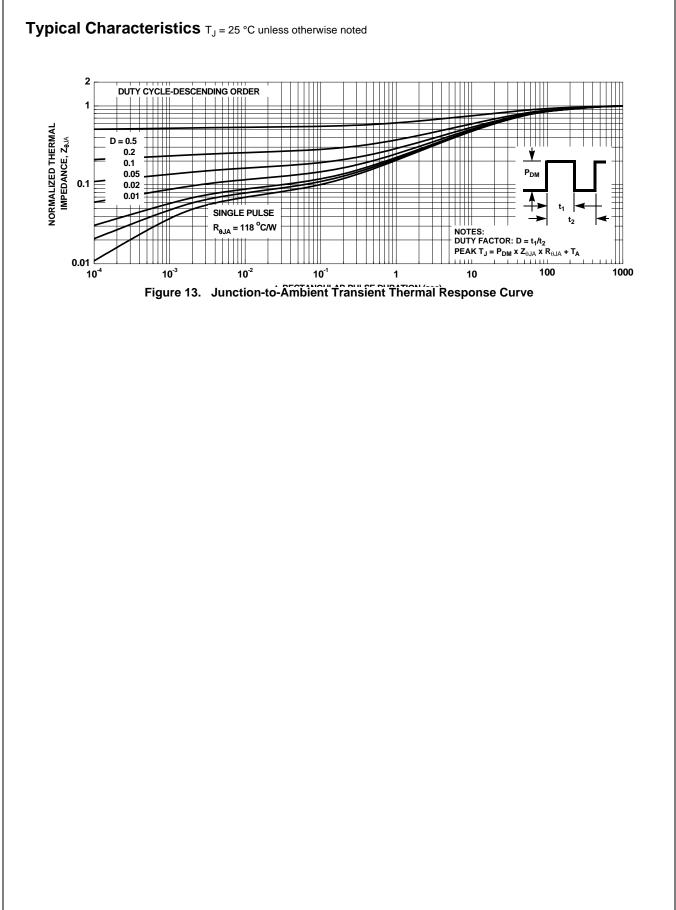
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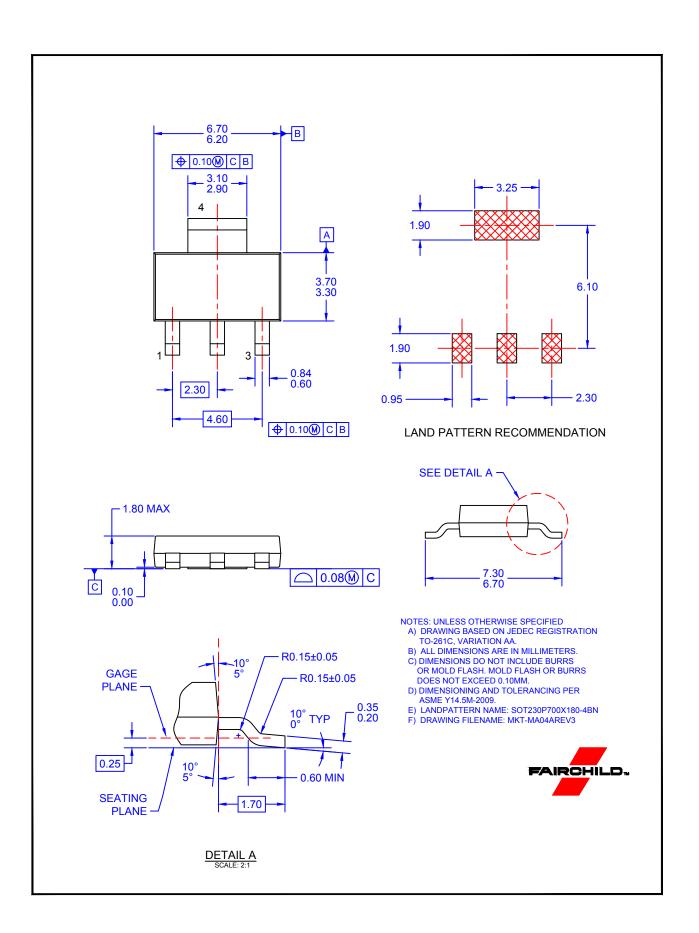
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